

Abstract

In a method of coating substrates, especially printed circuit boards, on both sides, one side of the substrate, which is provided with holes, is coated by means of a coating process, especially by screen printing, in such a manner that the holes that are not required for the circuit layout are lastingly covered over and the holes that are required are covered over only slightly or are left clear, whereupon the other side of the substrate is coated by means of a coating process, especially by curtain pouring or spraying, in such a manner that the entire surface of the substrate is provided uniformly with a coating that gives only a light covering over the holes.